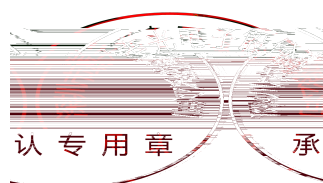


SPECIFICATION



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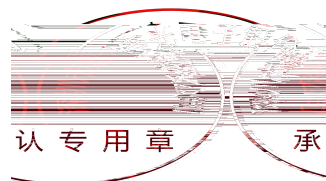
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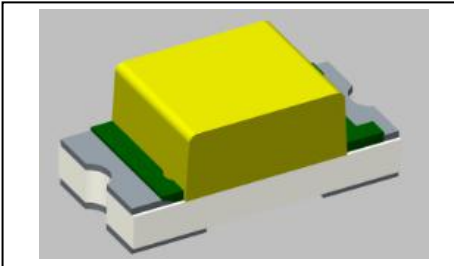
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1. Description

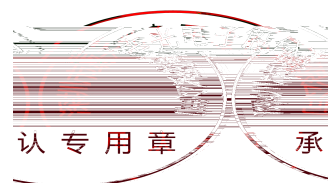
1.1 General Description



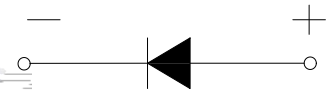
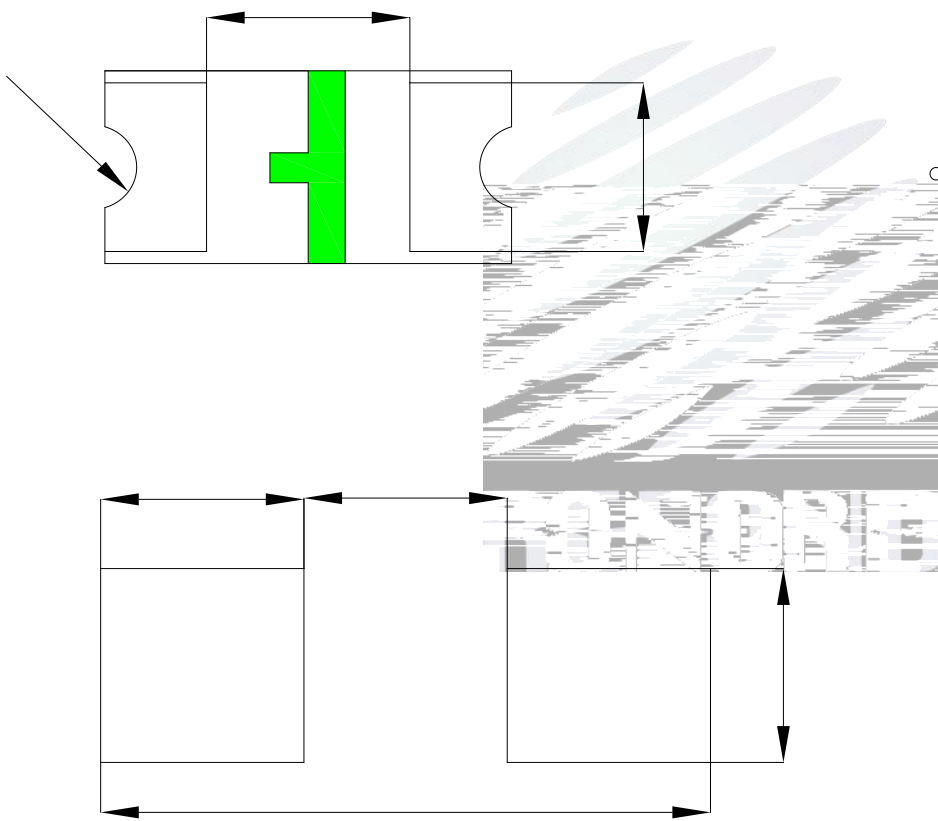
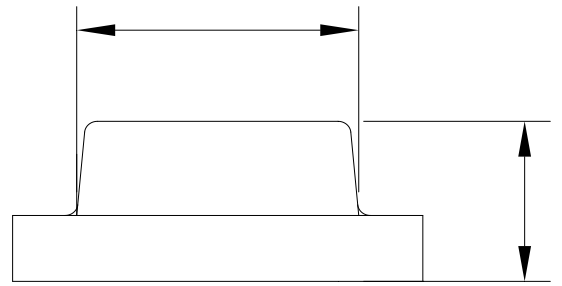
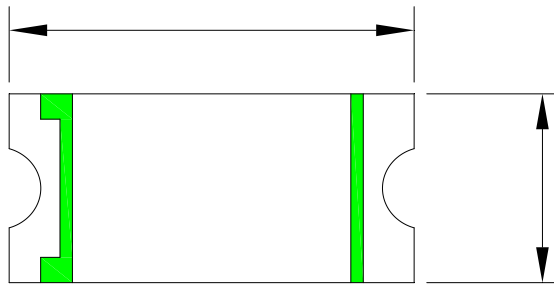
1.2 Features



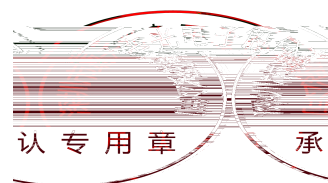
1.3 Application

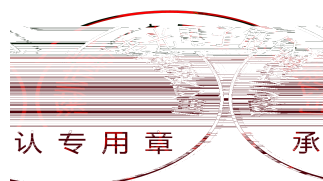


1.4 Package Dimension



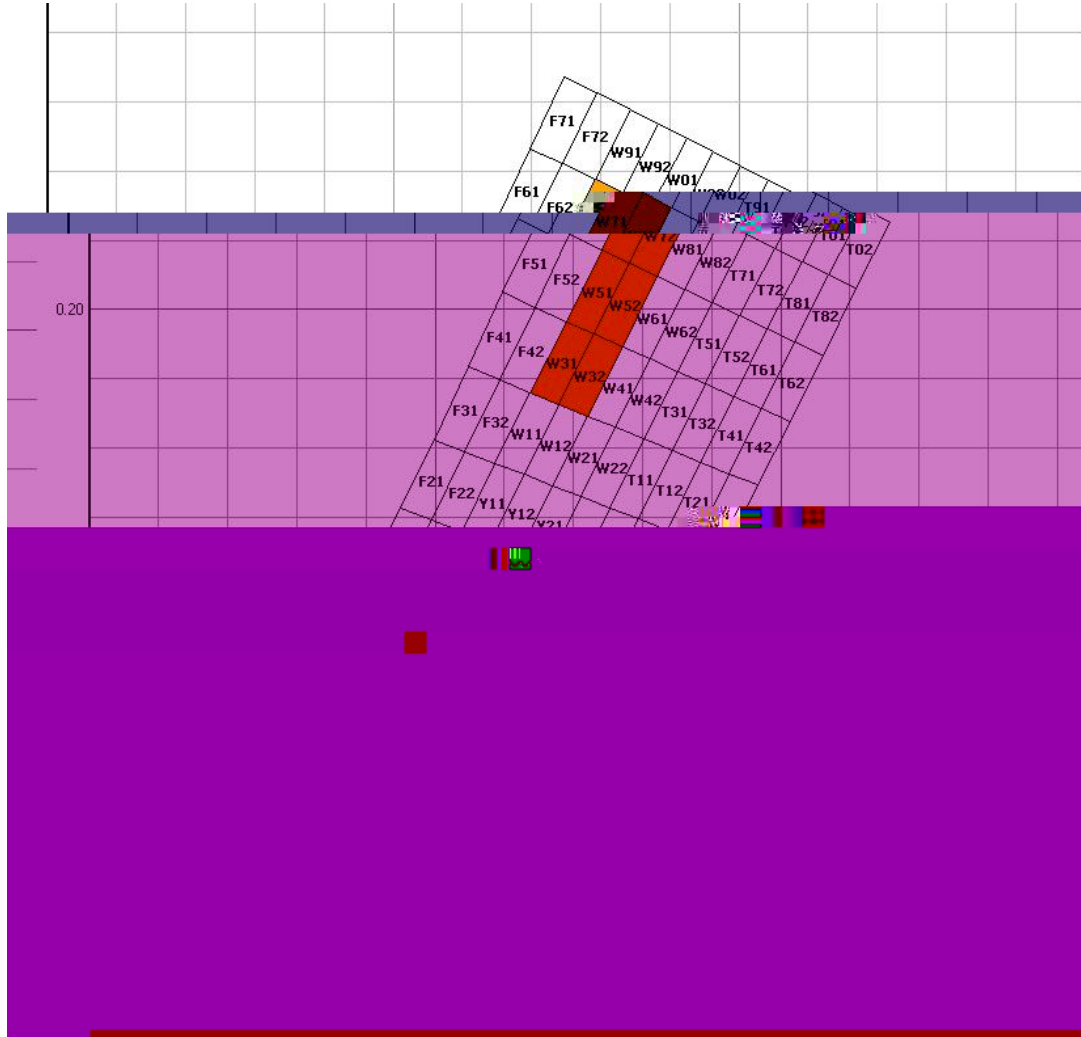
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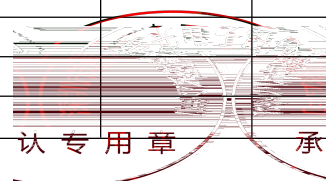


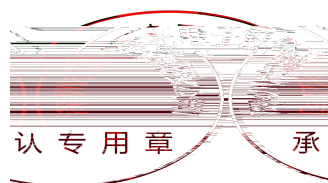


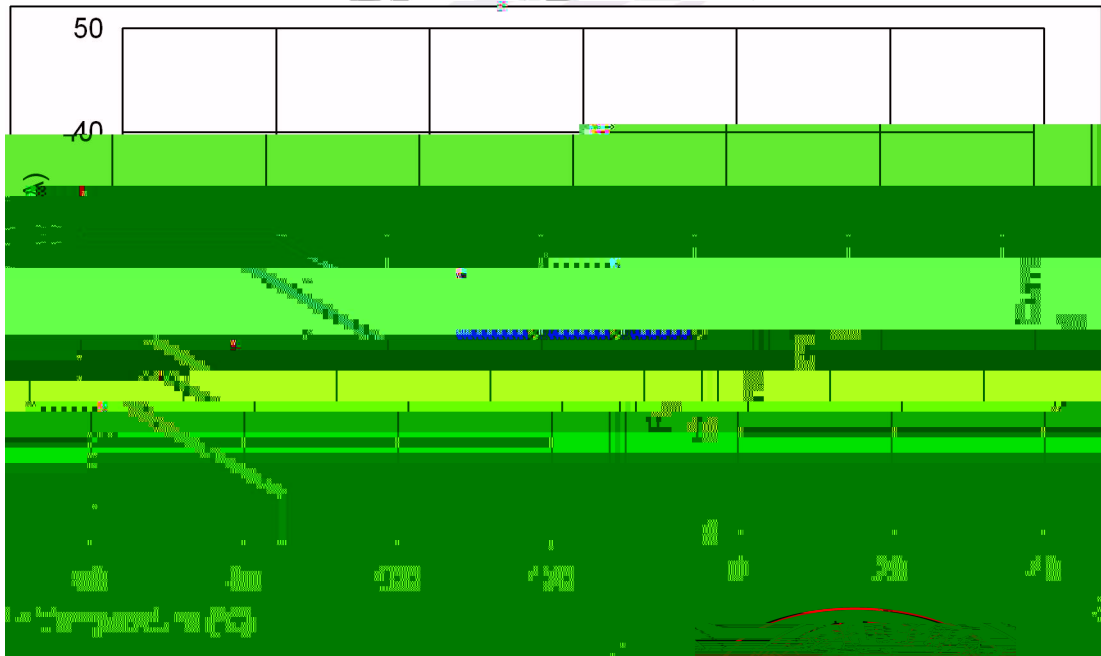
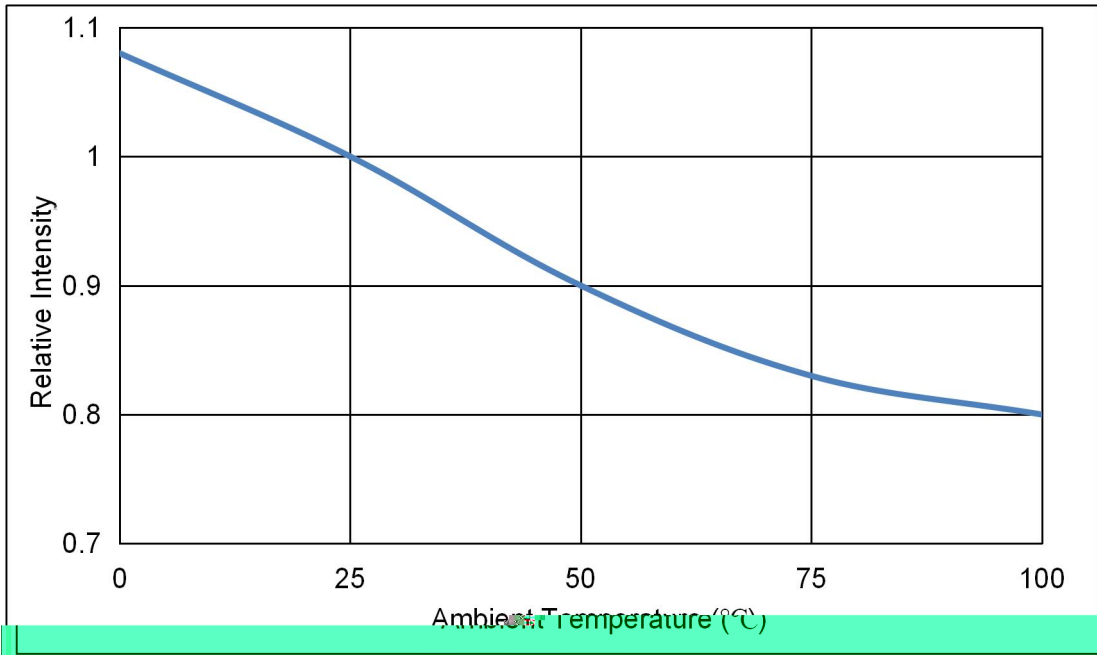
1.6 Bin Range Of Forward Voltage and Luminous Flux (IF=20mA)

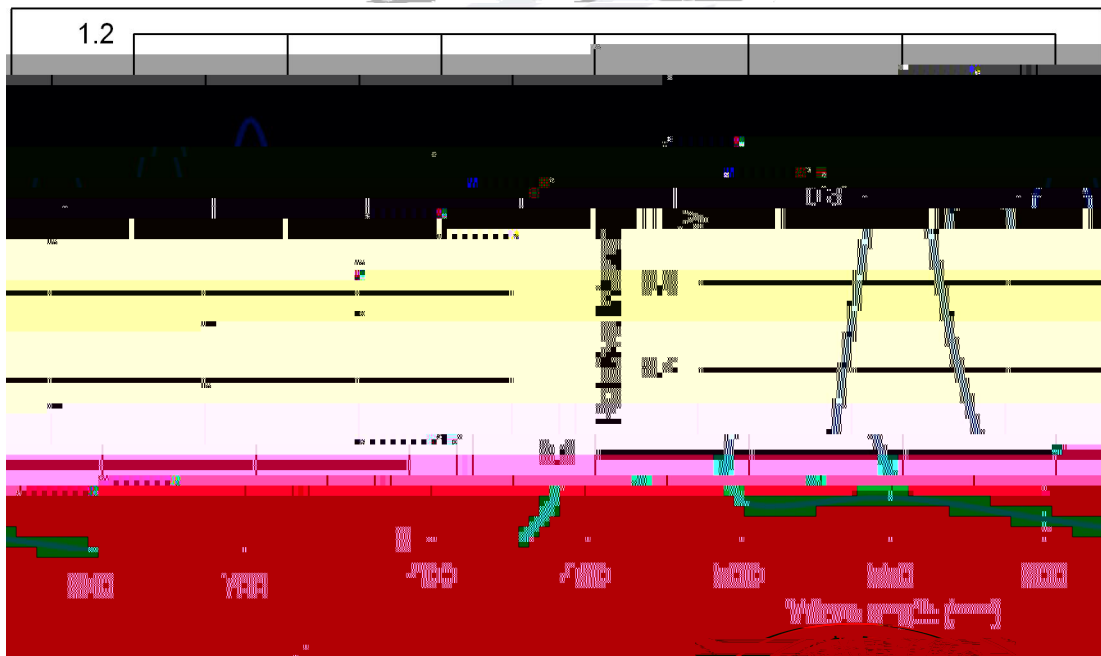
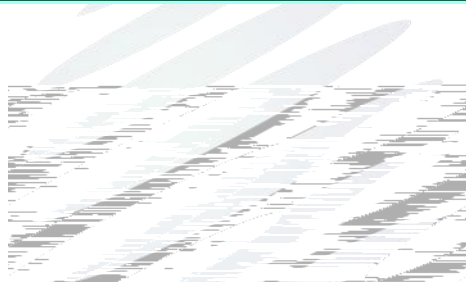
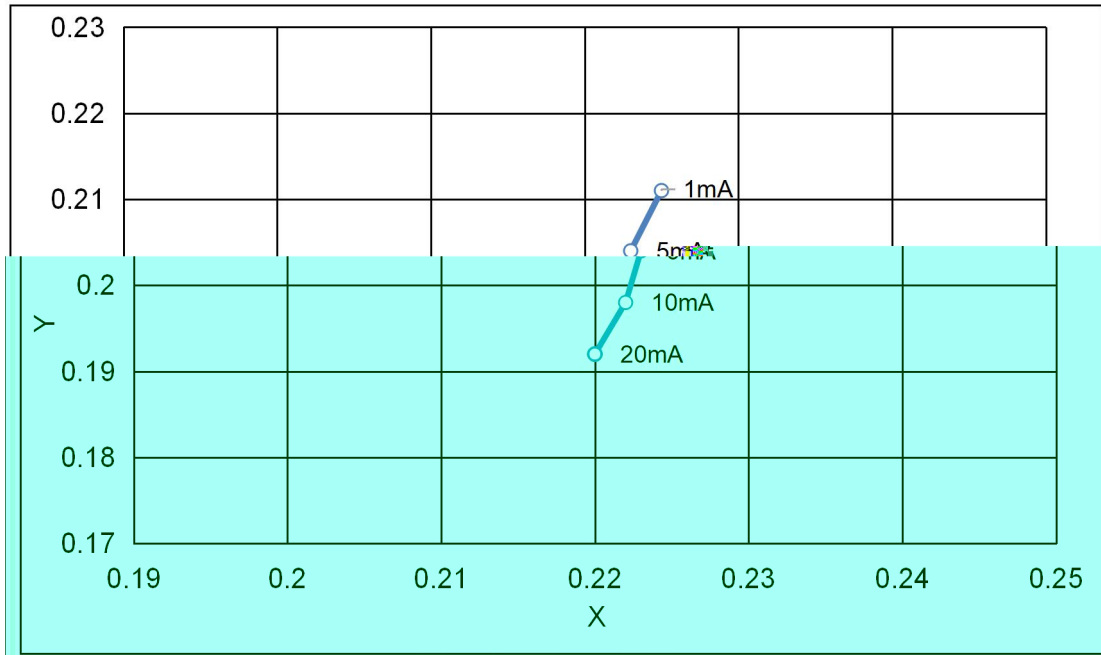
BIN (IF=20mA)

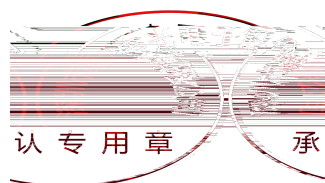
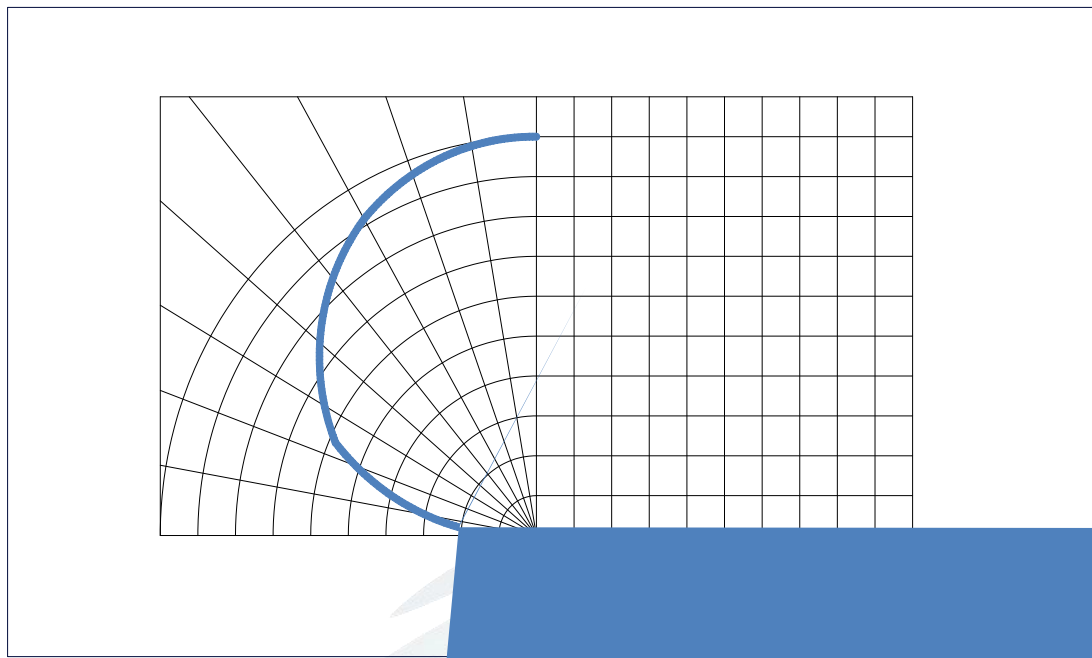






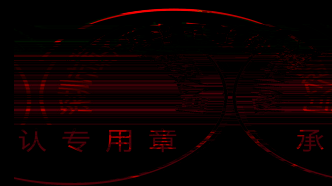
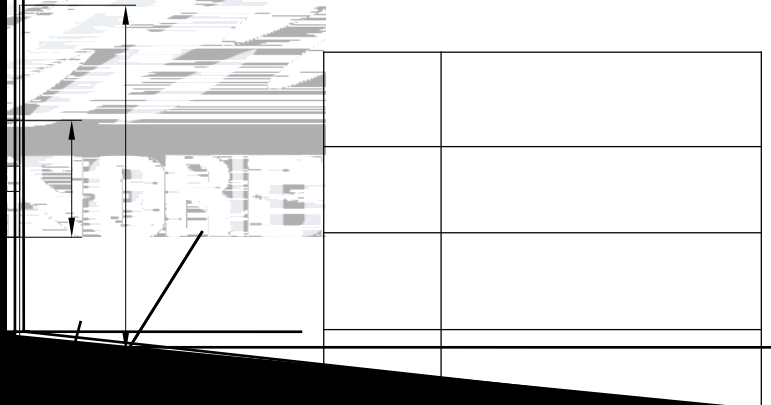
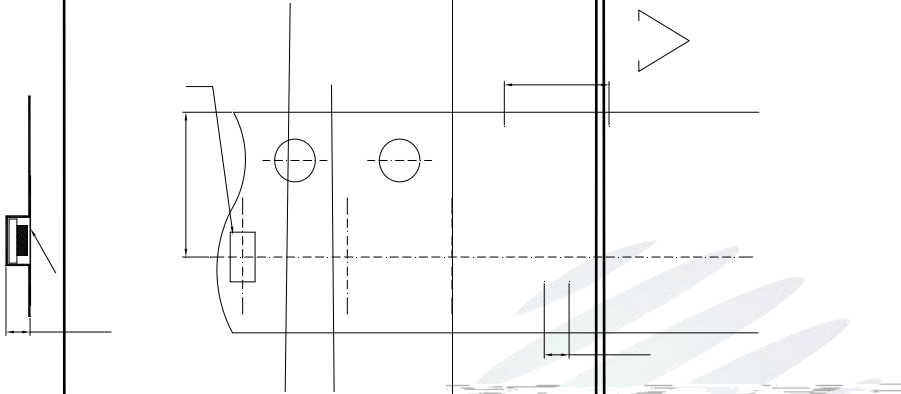






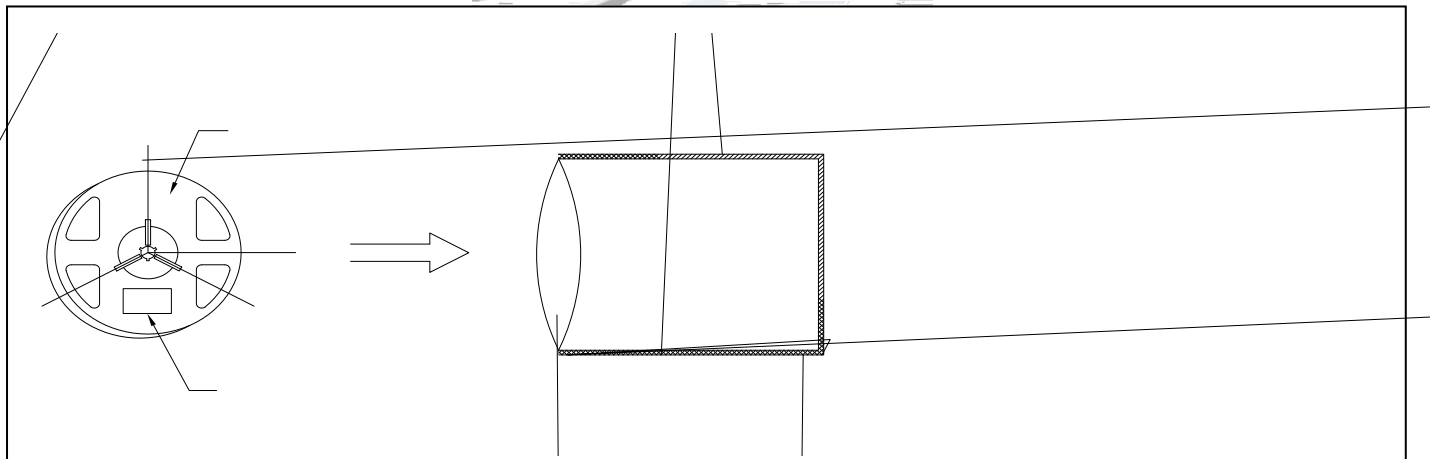
2. Packaging

2.1 Packaging Specification

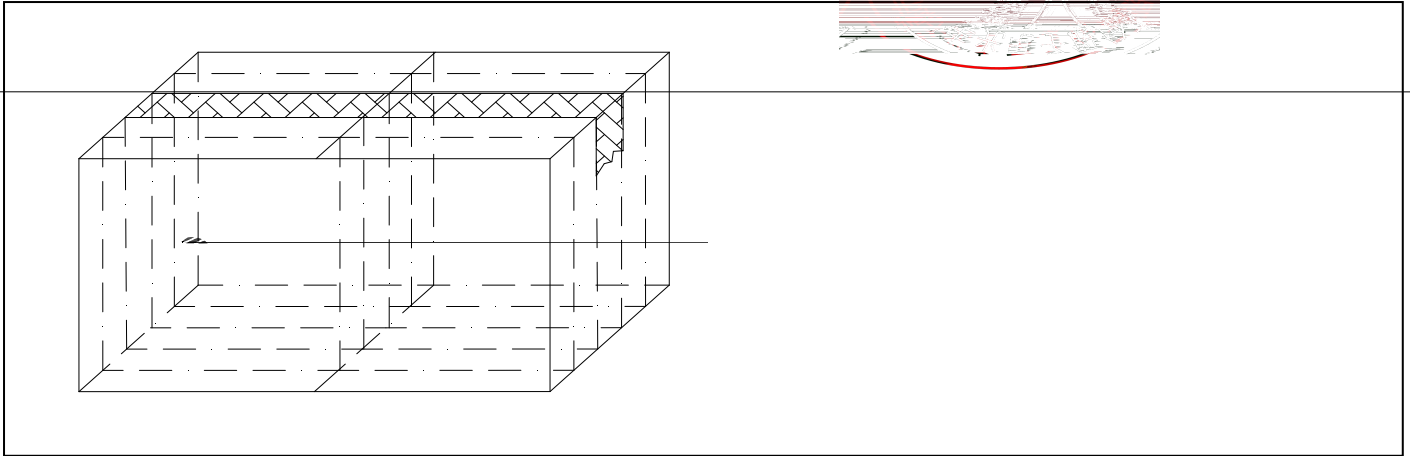
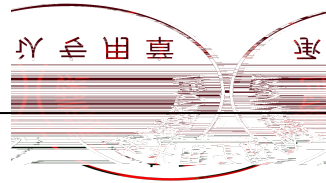




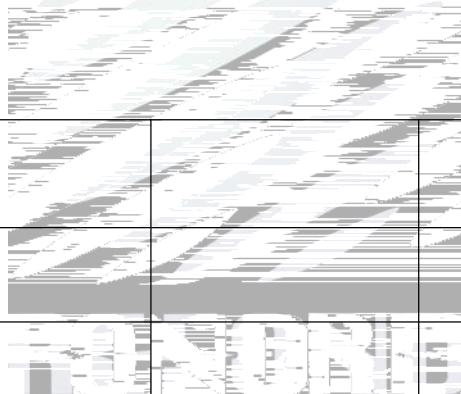
2.2 Moisture Resistant Packing



2.3 Cardboard Box

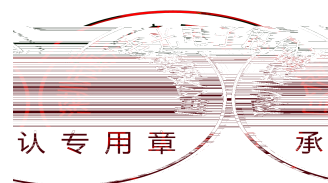


2.4 Reliability Test Items And Conditions



2.5 Criteria For Judging Damage

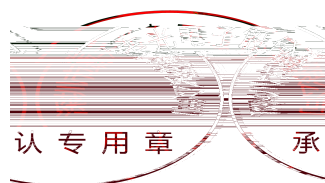
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3. SMT Reflow Soldering Instructions SMT

3.1 SMT Reflow Soldering Instructions SMT





4. Handling Precautions

4.1 Handling Precautions

